

Crystal oscillator



CRYSTAL OSCILLATOR (SPXO) OUTPUT : CMOS

SG2016CAA SG2520CAA

 Frequency 	:	19 standard frequencies
 Supply voltage 	:	1.8 V to 3.3 V Typ.
 Function 	:	Standby (st)
• • •		10 00 1 105 00

•Operation temperature : -40 °C to +125 °C

•AEC-Q200 compliant

	Pb	RoHS
	0	
For Automotive	Free	Compliant

SG2016CAA

(2.0 x 1.6 x 0.7 mm)

Product Number SG2016CAA: X1G005341xxxx00 SG2520CAA: X1G005951xxxx16

SG2520CAA

(2.5 x 2.0 x 0.8 mm)

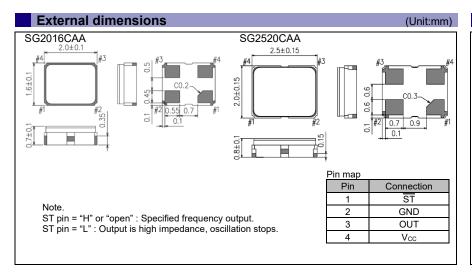
Specifications (c	character	ristics)							
Item	Symbol	Specifications				Conditions / Remarks			
Output frequency	fo	8 MHz 10 MHz 11.2896 MHz 12 MHz 12.288 MHz 14.7456 MHz 16.6666 MHz 20 MHz 22.5792 MHz 24 MHz 24 MHz 24.576 MHz 25 MHz 27 MHz 33 MHz 33.3333 MHz 40 MHz 48 MHz 50 MHz 54 MHz 56 MHz <th< td=""><td></td></th<>							
Supply voltage	Vcc	T: 1.60 V to 3.63 V							
Storage temperature range	T_stg		-55 °C to +125 °C		Storage	as single produ	ct.		
Operating temperature range	T_use	-	H: -40 °C to +105 °C J: -40 °C to +125 °C						
Frequency tolerance	f_tol		J: $\pm 50 \times 10^{-6}$ L: $\pm 100 \times 10^{-6}$						
	lcc	$V_{CC} = 1.8 V \pm 10 \%$	$V_{CC} = 2.5 V \pm 10 \%$	V _{CC} = 3.3 V ± 10 %					
Current consumption		2.0 mA Max.	2.1 mA Max.	2.3 mA Max.	No load condition, $8 \text{ MHz} \le \text{fo} \le 20 \text{ MHz}$				
		2.3 mA Max. 2.6 mA Max.	2.5 mA Max. 2.9 mA Max.	2.7 mA Max. 3.1 mA Max.	No load condition, 20 MHz < fo \leq 40 MHz No load condition, 40 MHz < fo \leq 54 MHz				
Stand-by current	l std	2.7 µA Max. 3.1 µA Max. 3.3 µA Max.			ST =GN	D			
Symmetry	SYM	45 % to 55 %			50 % Vc	c level, L CMO	S ≤ 15 pF		
	Vон	90 % V _{CC} Min.				1.8 V±10 % -1.5 mA	2.5 V±10 % -3 mA	3.3 V±10 % -4 mA	
	Vol	10 % V _{cc} Max.				1.5 mA	3 mA	4 mA	
Output voltage	Vон	V _{CC} - 0.4 V Min.				1.8 V±10 %	2.5 V±10 %	3.3 V±10 %	
	Vol	0.4 V Max.				-3 mA 3 mA	-4 mA 4 mA	-6 mA 6 mA	
Output load condition	L_CMOS	15 pF Max.							
		80 % V _{CC} Min.							
Input voltage	VIL		20 % Vcc Max.	- S ⊤ terminal					
Rise time and Fall time	tr/ tf	3 ns Max. 3.5 ns Max. (@1.8 V±10 %)				20 %V _{CC} to 80 %V _{CC} level, L_CMOS = 15 pF			
Start-up time	t_str	5 ms Max.				t = 0 at 90 % V _{CC}			
Frequency aging	f_age	$\pm 3 \times 10^{-6}$ / year Max.				First year			

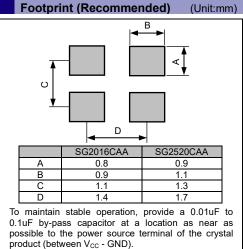
Product Name (Standard form)

 SG2016CAA
 25.000000MHz
 T J H A

 Model Name
 Frequency
 ①②③ L
 Standard Specification A

		-		
①Su	pply voltage	②Frequency tolerance / ③Operating temper		equency tolerance / ③Operating temperature
Т	1.8 V to 3.3 V Typ.	JH ±50 × 10 ⁻⁶ / -40 °C to +105 °C		$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C
			LJ	±100 × 10 ⁻⁶ / -40 °C to +125 °C





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